



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:)
DEANE ET AL) Atty Docket No.:
) **78153CIP1 (17-2 US**
CIP1)
Serial No. **10/775,395**)
) Art Group: **1725**
Confirmation No. **8888**)
)
Filing Date: **FEBRUARY 10, 2004**)
)
For: **SOLDER BONDING TECHNIQUE FOR**)
 ASSEMBLING A TILTED CHIP)
 OR SUBSTRATE)
)

TRANSMITTAL OF FORMAL DRAWINGS

Mail Stop Missing Parts
Commissioner of Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Enclosed are **Thirteen (13)** sheets of formal drawings to be filed in the above-identified patent application.

Respectfully submitted,

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